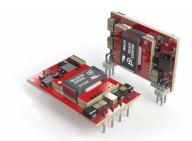


5.7kVDC Isolated 6W Gate Drive SIP/DIP DC-DC Converters



FEATURES

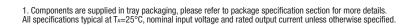
- Patent protected
- No opto feedback
- Optimised bipolar output voltages for IGBT/ SiC & MOSFET gate drives
- Configurable dual outputs for all gate drive applications:
 - +15V/-5V, +15V/-10V & +20V/-5V outputs
- Reinforced insulation to UL60950 recognised
- ANSI/AAMI ES60601-1, 2MOPP recognised
- Characterised CMTI >100kV/uS
- Characterised partial discharge performance
- 5.7kVDC isolation test voltage 'Hi Pot Test'
- Ultra low isolation capacitance 15pF
- Continuous barrier withstand voltage 3kVDC
- 5V, 12V & 24V input voltages
- 105°C operating temperature

PRODUCT OVERVIEW

Offering configurable dual output voltages of +15V/-10V, +20V/-5V and +15V/-5V, the MGJ6 series of DC-DC converters is ideal for powering 'high side' and 'low side' gate drive circuits for IGBTs, Silicon Carbide and MOSFETs in bridge circuits.

A choice of asymmetric output voltages allows optimum drive levels for best system efficiency and EMI. The MGJ6 series is characterised for high isolation and dv/dt requirements commonly seen in bridge circuits used in motor drives and inverters. A disable/frequency synchronisation pin simplifies EMC filter design. The MGJ6 protection features include short circuit protection and overload protection.







SELECTION GUIDE Output 1 Output 2 Rated Output Voltage Rated Output Current Rated Output Voltage **Output Current** Package style **Dutput Power** Output Power Input Rated Voltage Typical Application Range ٧ W ٧ mΑ W mΑ Order Code¹ See page 9 MGJ6D051510DC IGBT 4.5 - 9 +15 240 3.6 -10 240 2.4 MGJ6D121510DC 9 - 18**IGBT** +15240 36 -10 240 24 MGJ6D241510DC 18 - 36 IGBT 240 -10 240 2.4 +15 36 MGJ6D052005DC 4.5 - 9 SiC +20 240 4.8 -5 240 1.2 MGJ6D122005DC 9 - 18 SiC +20 240 48 -5 240 1.2 DIP MGJ6D242005DC 18 - 36 SiC +20 4.8 -5 240 1.2 240 MGJ6D051505DC 4.5 - 9 MOSFET +15 300 4.5 -5 300 1.5 MGJ6D121505DC 9 - 18 MOSFET +15 300 4.5 -5 300 1.5 MGJ6D241505DC 18 - 36 MOSFET 300 4.5 -5 300 1.5 +15MGJ6D051510SC 4.5 - 9 IGBT 3.6 -10 2.4 +15 240 240 MGJ6D121510SC **IGBT** 3.6 -10 240 24 9 - 18 +15 240 MGJ6D241510SC 18 - 36 **IGBT** +15 240 3.6 -10 240 2.4 MGJ6D052005SC 4.5 - 9 SiC +20 240 4.8 -5 240 1.2 MGJ6D122005SC 9 - 18 SiC +20 240 4.8 -5 240 1.2 SIP MGJ6D242005SC SiC +20 240 -5 240 1.2 18 - 36 4.8 MGJ6D051505SC 4.5 - 9 MOSFET +15 300 4.5 -5 300 1.5 MGJ6D121505SC 9 - 18MOSFET +15 300 4.5 -5 300 1.5 MGJ6D241505SC MOSFFT 300 4.5 -5 300 1.5 18 - 36 +15

			Output 1				Outp	ut 2		
	Input Voltage Range	Typical Application	Load Regulation (Typ) ³	Load Regulation (Max) ³	Ripple & Noise (Typ) ²	Ripple & Noise (Max) ²	Load Regulation (Typ)	Load Regulation (Max)	Ripple & Noise (Typ) ²	Ripple & Noise (Max) ²
Order Code ¹	V	See page 9	0	%	m۷	/p-p	0	6	mV	р-р
MGJ6D051510DC	4.5 - 9	IGBT	5	10	150	200	5	10	70	110
MGJ6D121510DC	9 - 18	IGBT	5	10	150	200	5	10	70	110
/IGJ6D241510DC	18 - 36	IGBT	5	10	150	200	5	10	70	110
/IGJ6D052005DC	4.5 - 9	SiC	5	10	150	200	5	10	70	110
IGJ6D122005DC	9 - 18	SiC	5	10	150	200	5	10	70	110
IGJ6D242005DC	18 - 36	SiC	5	10	150	200	5	10	70	110
IGJ6D051505DC	4.5 - 9	MOSFET	5	10	150	200	5	10	70	110
IGJ6D121505DC	9 - 18	MOSFET	5	10	150	200	5	10	70	110
NGJ6D241505DC	18 - 36	MOSFET	5	10	150	200	5	10	70	110
/IGJ6D051510SC	4.5 - 9	IGBT	5	10	150	200	5	10	70	110
NGJ6D121510SC	9 - 18	IGBT	5	10	150	200	5	10	70	110
NGJ6D241510SC	18 - 36	IGBT	5	10	150	200	5	10	70	110
/IGJ6D052005SC	4.5 - 9	SiC	5	10	150	200	5	10	70	110
/IGJ6D122005SC	9 - 18	SiC	5	10	150	200	5	10	70	110
NGJ6D242005SC	18 - 36	SiC	5	10	150	200	5	10	70	110
// AGJ6D051505SC	4.5 - 9	MOSFET	5	10	150	200	5	10	70	110
IGJ6D121505SC	9 - 18	MOSFET	5	10	150	200	5	10	70	110
MGJ6D241505SC	18 - 36	MOSFET	5	10	150	200	5	10	70	110

 $^{1.} Components \ are \ supplied \ in \ tray \ packaging, \ please \ refer \ to \ package \ specification \ section \ for \ more \ details.$

^{2.} See ripple & noise test method.

^{3.} Between 50% and 100% rated output current.

SELECTION GUIDE (C	ontinued)						
	.				ance		TF ²
Order Code ¹	Nominal Input Voltage	Input Current at Rated Load	Efficiency (Min)	Efficiency (Typ)	Isolation Capacitance	MIL 217	Telecordia
	V	mA	9	6	pF	kH	Irs
MGJ6D051510DC	5	1500	77.5	80	15	627	12,576
MGJ6D121510DC	12	620	77.5	80	15	789	19,546
MGJ6D241510DC	24	300	80	82	15	784	19,570
MGJ6D052005DC	5	1500	77.5	80	15	627	12,576
MGJ6D122005DC	12	620	77.5	80	15	789	19,546
MGJ6D242005DC	24	300	80	82	15	784	19,570
MGJ6D051505DC	5	1500	77.5	80	15	627	12,576
MGJ6D121505DC	12	620	77.5	80	15	789	19,546
MGJ6D241505DC	24	300	80	82	15	784	19,570
MGJ6D051510SC	5	1500	74	77.5	15	492	13,469
MGJ6D121510SC	12	620	78	80.5	15	789	19,546
MGJ6D241510SC	24	300	80	82	15	784	19,570
MGJ6D052005SC	5	1500	74	77.5	15	492	13,469
MGJ6D122005SC	12	620	78	80.5	15	789	19,546
MGJ6D242005SC	24	300	80	82	15	784	19,570
MGJ6D051505SC	5	1500	74	77.5	15	492	13,469
MGJ6D121505SC	12	620	78	80.5	15	789	19,546
MGJ6D241505SC	24	300	80	82	15	784	19,570

^{1.} Components are supplied in tray packaging, please refer to package specification section for more details.

^{2.}Calculated using MIL-HDBK-217 FN2 and Telcordia SR-332 calculation model with nominal input voltage at full load.

INPUT CHARACTERISTICS					
Parameter	Conditions	Min.	Тур.	Max.	Units
	5V input types	4.5	5	9	
Voltage range	12V input types	9	12	18	V
	24V input types	18	24	36	
	Turn on threshold MGJ6D05		4.1		
	Turn off threshold MGJ6D05		3.0		
Under voltage lock out	Turn on threshold MGJ6D12		8.1		V
orider voltage lock out	Turn off threshold MGJ6D12		7.5		, v
	Turn on threshold MGJ6D24		16.7		
	Turn off threshold MGJ6D24		16.3		
	5V input types		20		
Input ripple current	12V input types		50		mA
	24V input types		38		р-р

OUTPUT CHARACTERISTICS					
Parameter	Conditions	Min.	Тур.	Max.	Units
Minimum load	Below 10% load, 5V and 15V outputs are clamped to 6V and 17V respectively	10			%
Vallage and anish accounts.	Output 1		±3		%
Voltage set point accuracy	Output 2		±5		%
Line regulation	Low line to high line			2	%
Total Regulation				15	%
Transient response	Peak deviation (50-100% & 100-50% load swing)		0.4		%V _{out}
	Settling time		0.1		ms

GENERAL CHARACTERISTICS					
Parameter	Conditions	Min.	Тур.	Max.	Units
Switching frequency			100		kHz

ISOLATION CHARACT	TERISTICS							
Parameter	rameter Conditions		Min.	Тур.	Max.	Units		
Isolation test voltage		Production tested for 1 sec	Production tested for 1 second		5700			VDC
		Qualification tested for 1 minute		5700			VDC	
Resistance		Viso = 1kVDC		100			GΩ	
Continuous barrier withstand voltage		Non-safety barrier application				3000	VDC	
Safety standard	UL60950-1	Reinforced		Creepage and clearance 8mm			250	Vrmo
	ANSI/AAMI ES60601-1	2 MOPP	(250	Vrms

TEMPERATURE CHARACTERISTICS						
Parameter	Conditions	Min.	Тур.	Max.	Units	
Operation	See derating graphs	-40		105		
Storage		-50		125	°C	
Product temperature rise above ambient	100% Load, Nom VIN, Still Air		30			

ABSOLUTE MAXIMUM RATINGS	
Short-circuit protection	Continuous
Lead temperature 1.0mm from case for 10 seconds (to JEDEC JESD22-B106)	260°C
Input voltage, MGJ6 5V input types	12V
Input voltage, MGJ6 12V input types	20V
Input voltage, MGJ6 24V input types	40V
Wave Solder	Wave Solder profile not to exceed the profile recommended in IEC 61760-1 Section 6.1.3. Please refer to <u>application notes</u> for further information.



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TECHNICAL NOTES

ISOLATION VOLTAGE

'Hi Pot Test', 'Flash Tested', 'Withstand Voltage', 'Proof Voltage', 'Dielectric Withstand Voltage' & 'Isolation Test Voltage' are all terms that relate to the same thing, a test voltage, applied for a specified time, across a component designed to provide electrical isolation, to verify the integrity of that isolation.

Murata Power Solutions MGJ6 series of DC-DC converters are all 100% production tested at 5.7kVDC for 1 second and have been qualification tested at 5.7kVDC for 1 minute.

The MGJ6 series is recognised by Underwriters Laboratory, please see safety approval section for more information. When the insulation in the MGJ6 series is not used as a safety barrier, i.e. provides functional isolation only, continuous or switched voltages across the barrier up to 3kV are sustainable. This is established by measuring the partial discharge Inception voltage in accordance with IEC 60270. Please contact Murata for further information.

REPEATED HIGH-VOLTAGE ISOLATION TESTING

It is well known that repeated high-voltage isolation testing of a barrier component can actually degrade isolation capability, to a lesser or greater degree depending on materials, construction and environment. We therefore strongly advise against repeated high voltage isolation testing, but if it is absolutely required, that the voltage be reduced by 20% from specified test voltage.

SAFETY APPROVAL

ANSI/AAMI ES60601-1

The MGJ6 series has been recognised by Underwriters Laboratory (UL) to ANSI/AAMI ES60601-1 and provides 2 MOPP (Means Of Patient Protection) based upon a working voltage of 250 Vrms max., between Primary and Secondary.

UL 60950

The MGJ6 series has been recognised by Underwriters Laboratory (UL) to UL 60950 for reinforced insulation to a working voltage of 250Vrms with a maximum measured product operating temperature of 130°C.

Creepage and clearance 8mm.

FUSING

The MGJ6 Series of converters are not internally fused so to meet the requirements of UL an anti-surge input line fuse should always be used with ratings as defined below.

Input Voltage, 12V 2A Input Voltage, 15V 1A

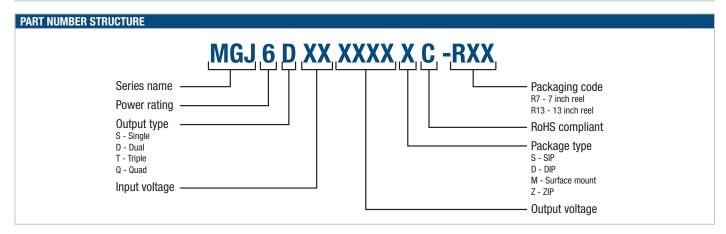
All fuses should be UL recognised, 125V rated.

Rohs Compliance, MSL, PSL and Soldering Information

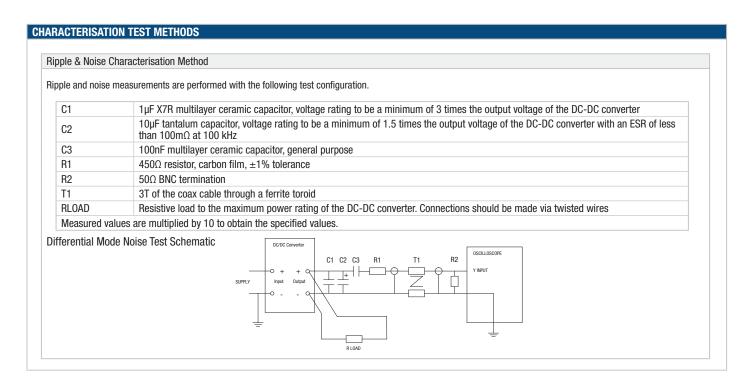


This series is compatible with RoHS soldering systems with a peak wave solder temperature of 260°C for 10 seconds based on IEC 61760-1. Please refer to <u>application notes</u> for further information. The pin termination finish on this product series is Tin with Nickel Preplate. The series is backward compatible with Sn/Pb soldering systems.

ENVIRONMENTAL VAL		And the state of t
		ease contact Murata if further information about the tests is required.
Test	Standard	Condition
Temperature cycling	JEDEC JESD22-A104	1000 cycles in a dual zone chamber from -40 (+5/-10)C to 105 (+10/-5)C. 15mins dwell at each (inclusive of ramps). 2 cycles per hour.
HAST (Unbiased)	JEDEC JESD22-A118	96Hrs +2/-0Hrs at 130°C ± 2°C, 85% ± 5% R.H.
High Temperature Storage life	JEDEC JESD22-A103, Condition A	125°C +10/-0°C for ≥1000 hours
Vibration	BS EN 61373 with respect to BS EN 60068-2-64, Test Fh Category 1 Class B	5 – 150Hz. Level at each axis – Vertical, Traverse and Longitudinal: 5.72m/s2 rms. 5 hours in each axis. Crest factor: 3 Sigma. Device is secured via pins
Shock	BS EN 61373, Category 1 Class B	Test is 30ms duration, 3 shocks in each sense of 3 mutually perpendicular axes (18 shocks total). Level at each axis: Vertical, Traverse and Longitudinal: 50m/s2. Device is secured via pins.
Solderability	IPC/ECA J-STD-002D. Test A1	Parts are baked for 4 hours at a temperature of 155°C within 72 hours they are dipped in flux for 10 seconds. Followed by dipping in a solder pot at 255 °C \pm 5°C for 5 seconds (96SC tin/silver/copper)
Solvent cleaning	Resistance to cleaning agents	Solvent – Novec 71IPA & Topklean EL-20A. Pulsed ultrasonic immersion 45°C- 65°C
Solvent Resistance	MIL-STD-883 Method 2015	The parts and the bristle portion of the brush are immersed in Isopropanol for a minimum of 1 minute. The part are brushed 3 times, after the third time the parts are blown dry and inspected.
Solder heat	JEDEC JESD22-B106	The test sample is subjected to a molten solder bath at 260 \pm 5°C for 10 +2/-0 seconds (96SC tin/silver/copper). The leads are dipped in the solder bath to within 1mm of the device body.
Lead Integrity (Adhesion)	MIL-STD 883 Method 2025	Leads are bent through 90° until a fracture occurs.
Lead Integrity (Fatigue)	MIL-STD 883 Method 2004, Condition B ₂	The leads are bent to an angle of 15°. Each lead is subjected to 3 cycles.







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APPLICATION NOTES

Disable/Frequency synchronisation

Please refer to application notes for further information.

		Min	Тур	Max	Units
	Pull Down Current		0.5		mA
Disable/Sync ¹	Input High	2		60	V
	Input Low	-0.6		8.0	V
Synchronisation	Frequency Range	90	100	110	kHz
Synchronisation	Duty Cycle	25		75	%

The Disable/Synchronization pin has three modes:

- 1. When a DC logic low voltage is applied to this pin the MGJ6 SIP/DIP is disabled and enters a low quiescent current sleep mode.
- When this pin is left floating or a DC logic high (CMOS/TTL compatible) voltage is applied the MGJ6 SIP/DIP is enabled and operates at the programmed frequency of 100kHz.
- 3. When a square wave of between 90kHz and 110kHz is applied to this pin, the switcher operates at the same frequency as the square wave. The falling edge of the square wave corresponds to the start of the switching cycle. If the signal is slower than 25Hz, it will be interpreted as enabling and disabling the part. If the MGJ6 SIP/DIP is disabled, it must be disabled for 7 clock cycles before being re-enabled.

Note: The Dis/Sync pin is a high impedance TTL input and can be triggered by noise from external circuits if not treated carefully.

Please refer to "LAYOUT CONSIDERATIONS" and "SYNCHRONISATION CIRCUIT" for further details.

Click here for general guidance for gate drive applications.

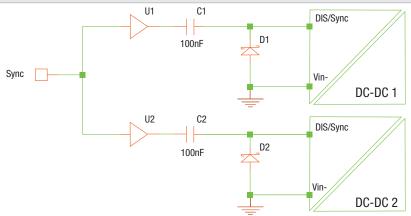
LAYOUT CONSIDERATIONS

Unlike standard isolated DC-DC products the MGJ6 SIP/DIP series has been designed specifically for high side gate drive applications where the outputs are being driven to a high voltage at a very high dV/dT. This is possible due to minimum transformer isolation capacitance and considered circuit design regarding common mode transient immunity. It is important that these few simple pcb layout guidelines are implemented so as not to compromise the performance of the DC-DC and that of the overall system.

- The keep clear area shown must not have any copper traces even on internal layers. This is not only to avoid compromising the creepage and clearance distance but
 also to minimise capacitive isolation between the noisy output circuits and input control circuits. In general it is good practice to maintain the same band of clearance
 area running directly through both the DC-DC and the gate drive isolators as shown so that input and output are kept separate and do not overlap or mesh together
 at any point.
- A top layer ground plane copper area connected to -Vin can be used to create an effective screen to the underside of the MGJ6 SIP/DIP series and can also be used
 as a guard ring for the gate drive isolator inputs. If the Dis/Synch pin is being used then it is imperative that it follows a route covered by this screen to avoid differential pick up. It should also be kept as short as possible.

Please refer to "PACKAGE SPECIFICATIONS" for recommended layout.

SYNCHRONISATION CIRCUIT



- 1. A suggested synchronisation circuit is shown. C1 and C2 are 100nF capacitors. D1 and D2 are schottky diodes. The capacitive isolation and close connected diode ensures that a transition from high to low is seen at the input pin even in a noisy environment or when there is a slight ground shift between devices.
- 2. If the Dis/Sync pin is not used for synchronisation, then a 22nF capacitor can be added between the Dis/Sync pin and –Vin pin to improve noise immunity. If the functionality of Dis/Sync is not required, the Dis/Sync pin can be connected directly to the +Vin pin to improve noise immunity.
- 3. One very effective method to reduce common mode transient interference is to add a common mode filter to the DC input. It may only be necessary to add one before splitting the supply to each DC-DC.

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APPLICATION NOTES (Continued)

Start-up times

Typical start up times for this series, with no additional output capacitance are:

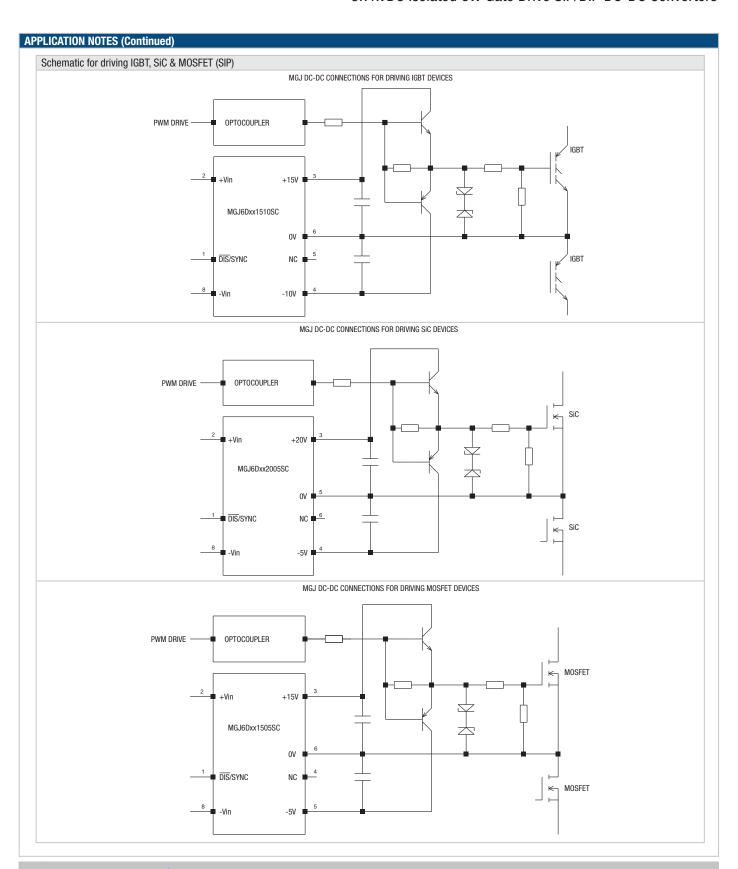
Part No.	Start-up times
	ms
MGJ6D051510DC	15
MGJ6D121510DC	15
MGJ6D241510DC	15
MGJ6D052005DC	15
MGJ6D122005DC	15
MGJ6D242005DC	15
MGJ6D051505DC	15
MGJ6D121505DC	15
MGJ6D241505DC	15
MGJ6D051510SC	15
MGJ6D121510SC	15
MGJ6D241510SC	15
MGJ6D052005SC	15
MGJ6D122005SC	15
MGJ6D242005SC	15
MGJ6D051505SC	15
MGJ6D121505SC	15
MGJ6D241505SC	15

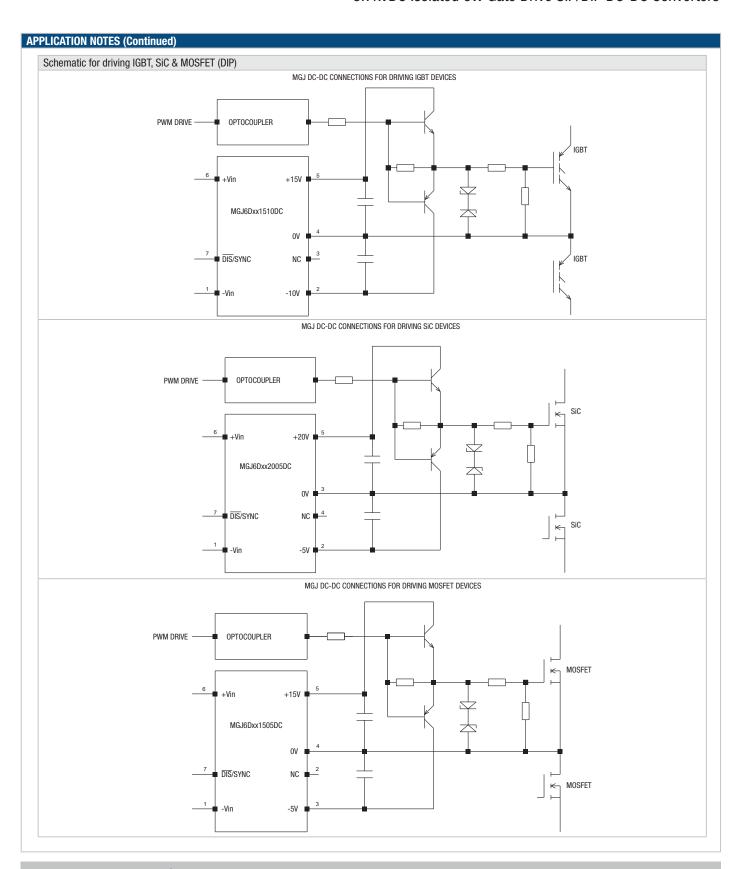
Output capacitance must not exceed:

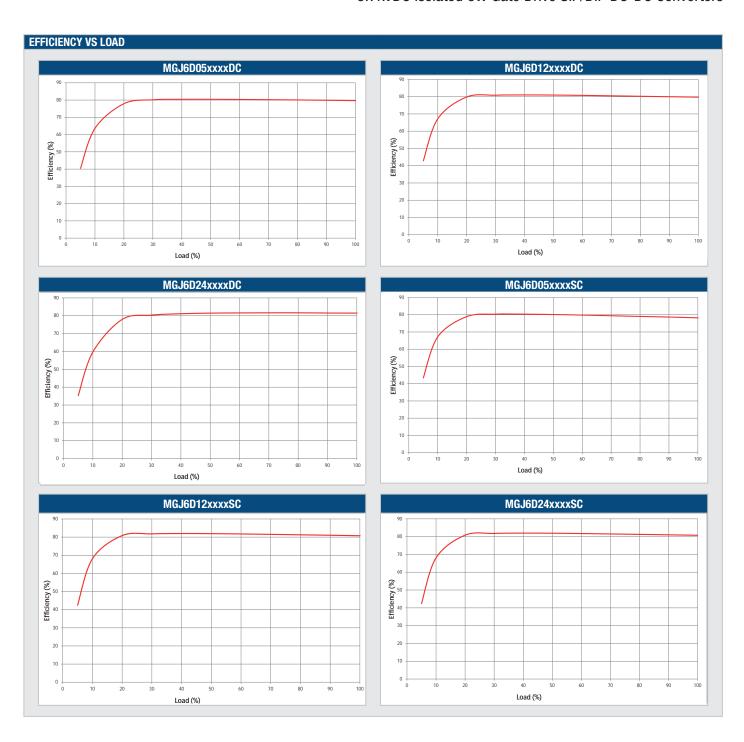
Output Voltage	Maximum output capacitance
V	μF
-5	470
-10	220
15	220
20	150

Output configurations for power switches

Terminal	Pin (SIP)	Pin (DIP)	IGBT	SIC	MOSFET	
15V Output	3	5	+15V 0.24A	+20V 0.24A	+15V 0.3A	
15V Return 5VA Output	6	4	OV	No connection	OV	
5VA Return 5VB Output	5	3	No connection	OV	-5V 0.3A	
5VB Return	4	2	-10V 0.24A	-5V 0.24A	No connection	



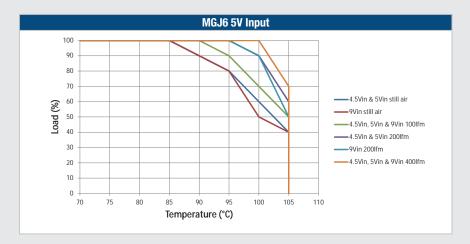


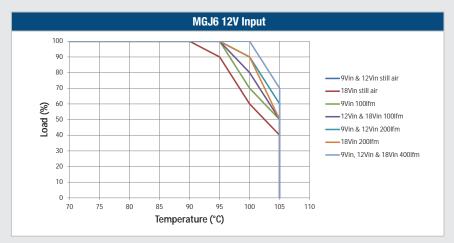


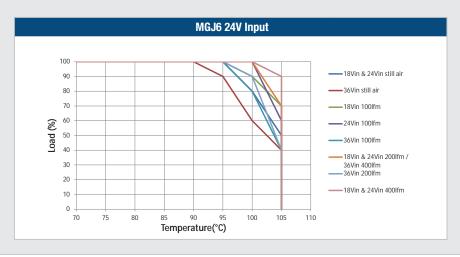
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DERATING GRAPHS

Derating curves are based on IPC-9592. With no derating some components may be operating at the manufacturers maximum temperature ratings.





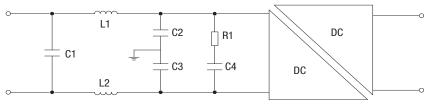


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EMC FILTERING AND SPECTRA

FILTERING

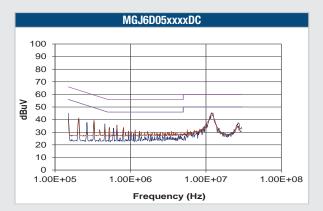
The following filter circuit and filter table shows the input filters typically required to meet EN 55022 Curve B, Quasi-Peak EMC limit, as shown in the following plots. The following plots show positive and negative quasi peak and CISPR22 Average Limit B (purple line) and Quasi Peak Limit B (pink line) adherence limits. If a high dv/dt above 80kV/us is expected from output to input it is advised that a common mode filter is used on the input without Y capacitors. This will reduce the common mode current and reduce interference with primary side circuits.

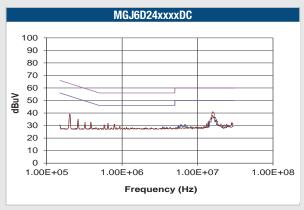


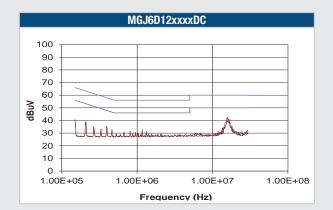
C1, C2 & C3 Polyester or ceramic capacitor

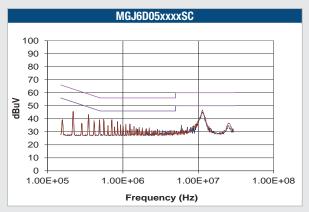
C4 Electrolytic capacitor (note R1 could be omitted if C4 has ESR >= R1)

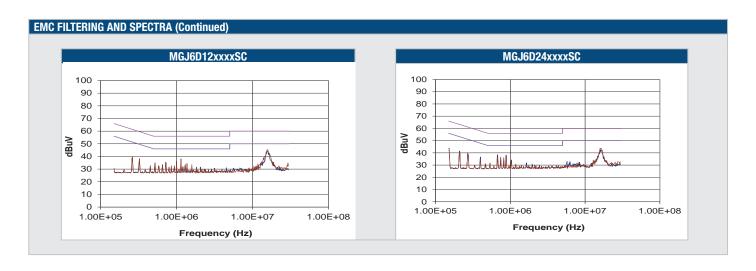
TO MEET CURVE B										
Part Number	C1	L1&2	Through Hole	C2&3	R1	C4				
MGJ6D05XXXXXC	3.3uF	10uH	47100SC	10nF	500mΩ	470uF				
MGJ6D12XXXXXC	3.3uF	10uH	47100SC	10nF	500mΩ	470uF				
MGJ6D24XXXXXC	3.3uF	10uH	47100SC	10nF	500m Ω	470uF				

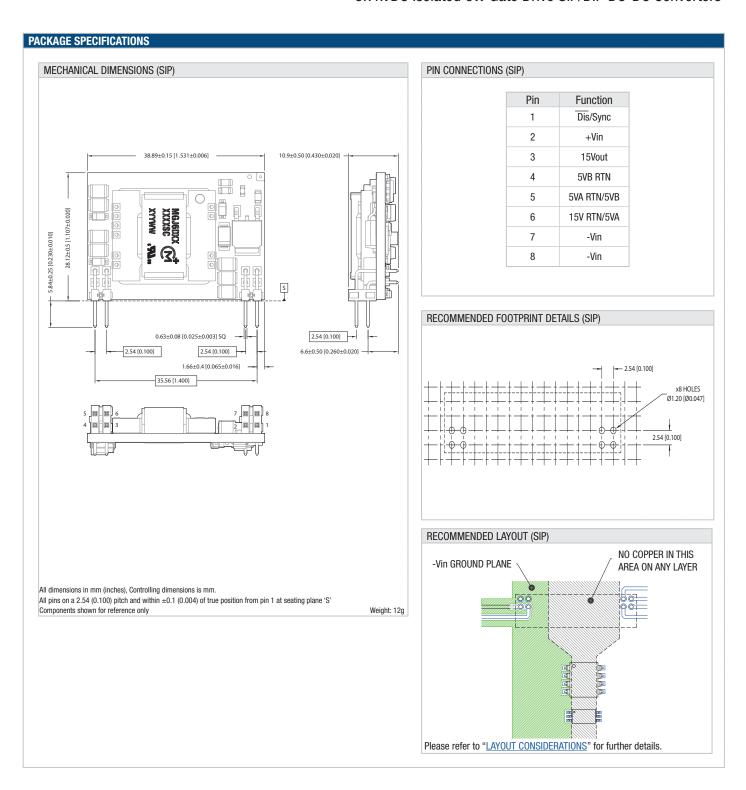




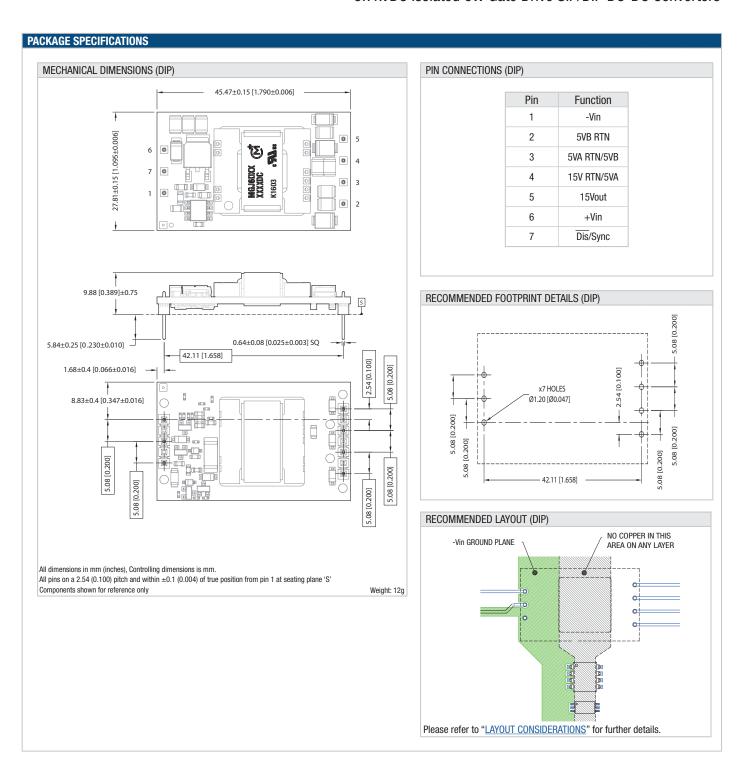




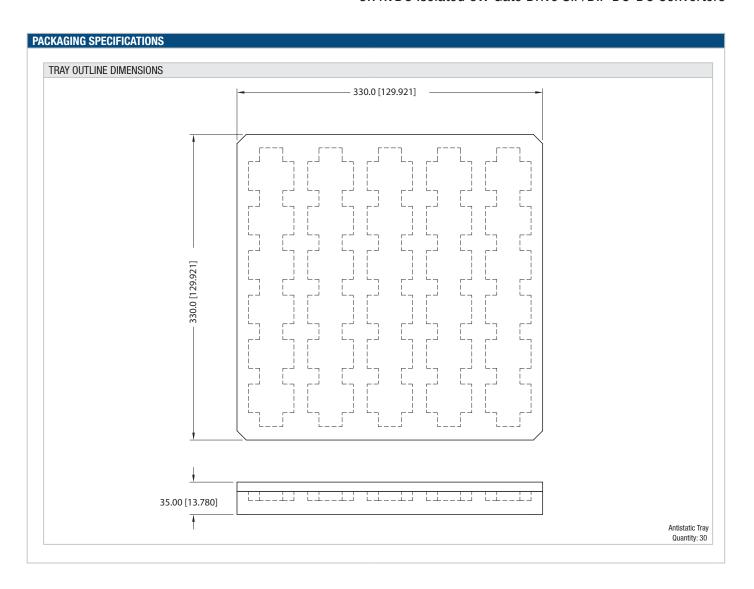








5.7kVDC Isolated 6W Gate Drive SIP/DIP DC-DC Converters





This product is subject to the following <u>operating requirements</u> and the <u>Life and Safety Critical Application Sales Policy</u>:

Refer to: http://www.murata-ps.com/requirements/

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